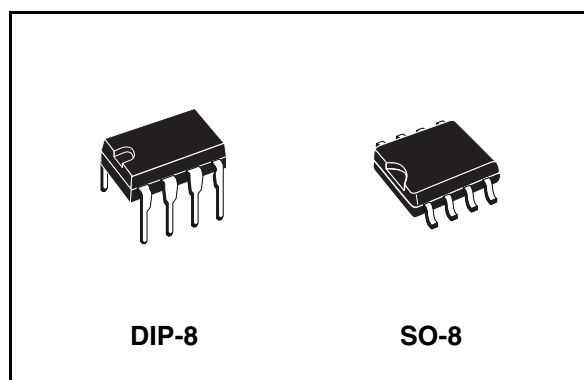


General features

- Low quiescent current: 300µA
- Designed for RS-485 interface application
- -7V to 12V common mode input voltage range
- Driver maintains high impedance in 3-state or with the power OFF
- 70mV typical input hysteresis
- 30ns propagation delay, 5ns skew
- Operates from a single 5V supply
- Current limiting and thermal shutdown for driver overload protection
- ESD protection:
 - ±15KV (H.B.M.)
 - ±8KV (IEC-1000-4-2 contact discharge)
- Allows up to 64 transceivers on the bus

Description

The ST485E is a low power transceiver for RS-485 and RS-422 communication. Each driver output and receiver input is protected against ±15KV electrostatic discharge (H.B.M.) (ESD) shocks, without latch-up. These parts contain one



driver and one receiver in half duplex configuration.

This transceiver draws 300µA (typ.) of supply current when unloaded or fully loaded with disabled drivers.

It operates from a single 5V supply.

Driver is short-circuit current limited and is protected against excessive power dissipation by thermal shutdown circuitry that place the driver outputs into a high-impedance state.

The ST485E is designed for bi-directional data communications on multipoint bus transmission lines (half-duplex applications).

Order codes

Part numbers	Temperature range	Package	Packaging
ST485ECN	0 to 70 °C	DIP-8	50parts per tube / 40tube per box
ST485EBN	-40 to 85 °C	DIP-8	50parts per tube / 40tube per box
ST485EXN	-55 to 125 °C	DIP-8	50parts per tube / 40tube per box
ST485EBD	-40 to 85 °C	SO-8 (Tube)	100parts per tube / 20tube per box
ST485ECDR	0 to 70 °C	SO-8 (Tape & reel)	2500 parts per reel
ST485EBDR	-40 to 85 °C	SO-8 (Tape & reel)	2500 parts per reel
ST485EXDR	-55 to 125 °C	SO-8 (Tape & reel)	2500 parts per reel

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2	Truth tables	4
3	Maximum ratings	5
4	Electrical characteristics	6
5	Test circuit and typical characteristics	9
6	Package mechanical data	14
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1 Pin configuration

Figure 1. Pin connections (top view)

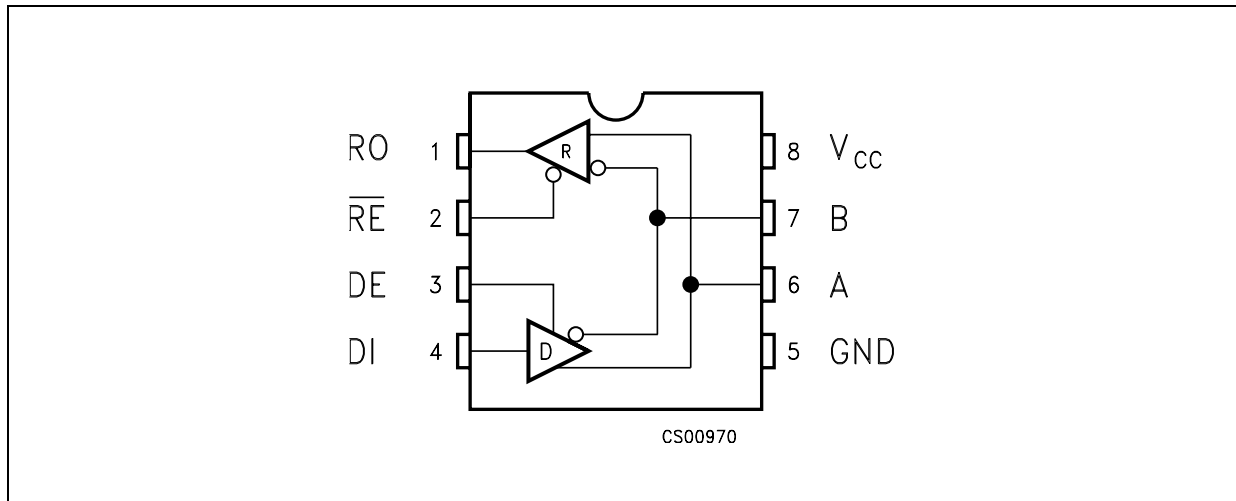


Table 1. Pin description

Pin n°	Symbol	Name and function
1	RO	Receiver output
2	\overline{RE}	Receiver output enable
3	DE	Driver output enable
4	DI	Driver input
5	GND	Ground
6	A	Non-inverting receiver input and non-inverting driver output
7	B	Inverting receiver input and inverting driver output
8	V _{CC}	Supply voltage

2 Truth tables

Table 2. Truth table (driver)

Inputs			Outputs	
RE	DE	DI	B	A
X	H	H	L	H
X	H	L	H	L
X	L	X	Z	Z

Note: X = Don't care; Z = High impedance

Table 3. Truth table (receiver)

Inputs			Outputs
RE	DE	A-B	RO
L	L	$\geq +0.2V$	H
L	L	$\leq -0.2V$	L
L	L	Inputs open	H
H	L	X	Z

Note: X = Don't care; Z = High impedance

3 Maximum ratings

Table 4. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	7	V
V_I	Control input voltage (\overline{RE} , DE)	-0.5 to ($V_{CC} + 0.5$)	V
V_{DI}	Driver input voltage (DI)	-0.5 to ($V_{CC} + 0.5$)	V
V_{DO}	Driver output voltage (A, B)	± 14	V
V_{RI}	Receiver input voltage (A, B)	± 14	V
V_{RO}	Receiver output voltage (RO)	-0.5 to ($V_{CC} + 0.5$)	V

Note: Absolute maximum ratings are those values beyond which damage to the device may occur. Functional operation under these is not implied. $V+$ and $V-$ can have a maximum magnitude of +7V, but their absolute addition exceed 13 V.

4 Electrical characteristics

Table 5. ESD Performance: transmitter outputs, receiver inputs

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
ESD	ESD Protection voltage	Human body model	±15			KV
ESD	ESD Protection voltage	IEC-1000-4-2	±8			KV

Table 6. DC Electrical characteristics ($V_{CC} = 5V \pm 5\%$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise specified. Typical values are referred to $T_A = 25^\circ C$)

Symbol	Parameter	Test conditions ⁽¹⁾	Min.	Typ.	Max.	Unit
V_{OD1}	Differential driver output (No Load)				5	V
V_{OD2}	Differential driver output (With Load)	$R_L = 27\Omega$ (RS-485) (Figure 2.) $R_L = 50\Omega$ (RS-422) (Figure 2.)	1.5		5 5	V V
ΔV_{OD}	Change in magnitude of driver differential output voltage for complementary output states	$R_L = 27\Omega$ or 50Ω (Figure 2.)			0.2	V
V_{OC}	Driver common-mode output voltage	$R_L = 27\Omega$ or 50Ω (Figure 2.)			3	V
ΔV_{OC}	Change in magnitude of driver common-mode output voltage for complementary output states	$R_L = 27\Omega$ or 50Ω (Figure 2.)			0.2	V
V_{IH}	Input high voltage	\overline{RE} , DE, DI	2.0			V
V_{IL}	Input low voltage	\overline{RE} , DE, DI			0.8	V
I_{IN1}	Input current	\overline{RE} , DE, DI			±2	μA
I_{IN2}	Input current (A, B)	$V_{CM} = 0V$ or $5.25V$, $V_{DE} = 0V$ $V_{IN} = 12V$ $V_{IN} = -7V$			1 -0.8	mA mA
V_{TH}	Receiver differential threshold voltage	$V_{CM} = -7$ to $12V$	-0.2		0.2	V
ΔV_{TH}	Receiver input hysteresis	$V_{CM} = 0V$		70		mV
V_{OH}	Receiver output high voltage	$I_O = -4mA$, $V_{ID} = 200mV$	3.5			V
V_{OL}	Receiver output low voltage	$I_O = 4mA$, $V_{ID} = -200mV$			0.4	V
I_{OZR}	3-State (high impedance) output current at receiver	$V_O = 0.4$ to $2.4V$			±1	μA
R_{IN}	Receiver input resistance	$V_{CM} = -7$ to $12V$	24			KΩ
I_{CC}	No load supply current ⁽²⁾	$V_{RE} = 0V$ or V_{CC} $V_{DE} = V_{CC}$ $V_{DE} = 0V$		400 300	900 500	μA μA
I_{OSD1}	Driver short-circuit current, $V_O = High$	$V_O = -7$ to $12V$ ⁽³⁾	35		250	mA

Table 6. DC Electrical characteristics ($V_{CC} = 5V \pm 5\%$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise specified. Typical values are referred to $T_A = 25^\circ C$)

Symbol	Parameter	Test conditions ⁽¹⁾	Min.	Typ.	Max.	Unit
I_{OSD2}	Driver short-circuit current, $V_O = \text{Low}$	$V_O = -7$ to $12V$ ⁽³⁾	35		250	mA
I_{OSR}	Receiver short-circuit current	$V_O = 0V$ to V_{CC}	7		95	mA

1. All currents into device pins are positive; all out of device pins are negative; all voltages are referenced to device ground unless specified.
2. Supply current specification is valid for loaded transmitters when $V_{DE} = 0V$
3. Applies to peak current. See typical Operating Characteristics.

Table 7. Driver switching characteristics ($V_{CC} = 5V \pm 5\%$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise specified. Typical values are referred to $T_A = 25^\circ C$)

Symbol	Parameter	Test conditions ⁽¹⁾	Min.	Typ.	Max.	Unit
t_{PLH} t_{PHL}	Propagation delay input to output	$R_{DIFF} = 54\Omega$, $C_{L1} = C_{L2} = 100pF$ (See Figure 4. and Figure 6.)		25	45	ns
t_{SK}	Output skew to output	$R_{DIFF} = 54\Omega$, $C_{L1} = C_{L2} = 100pF$ (See Figure 4. and Figure 6.)		2	5	ns
t_{TLH} t_{THL}	Rise or fall time	$R_{DIFF} = 54\Omega$, $C_{L1} = C_{L2} = 100pF$ (See Figure 4. and Figure 6.)		15	40	ns
t_{PZH}	Output enable time	$C_L = 100pF$, S2 = Closed (See Figure 5. and Figure 7.)		35	50	ns
t_{PZL}	Output enable time	$C_L = 100pF$, S1 = Closed (See Figure 5. and Figure 7.)		25	40	ns
t_{PLZ}	Output disable time	$C_L = 15pF$, S1 = Closed (See Figure 5. and Figure 7.)		25	40	ns
t_{PHZ}	Output disable time	$C_L = 15pF$, S2 = Closed (See Figure 5. and Figure 7.)		35	50	ns

1. All currents into device pins are positive; all out of device pins are negative; all voltages are referenced to device ground unless specified.

Table 8. Receiver switching characteristics ($V_{CC} = 5V \pm 5\%$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise specified. Typical values are referred to $T_A = 25^\circ C$)

Symbol	Parameter	Test conditions ⁽¹⁾	Min.	Typ.	Max.	Unit
t_{PLH} t_{PHL}	Propagation delay input to output	$R_{DIFF} = 54\Omega$, $C_{L1} = C_{L2} = 100pF$ (See Figure 4. and Figure 8.)		110	130	ns
t_{SKD}	Differential receiver skew	$R_{DIFF} = 54\Omega$, $C_{L1} = C_{L2} = 100pF$ (See Figure 4. and Figure 8.)		5	10	ns
t_{PZH}	Output enable time	$C_{RL} = 15pF$, S1 = Closed (See Fig. 2 and Figure 9.)		11	35	ns
t_{PZL}	Output enable time	$C_{RL} = 15pF$, S2 = Closed (See Fig. 2 and Figure 9.)		13	35	ns
t_{PLZ}	Output disable time	$C_{RL} = 15pF$, S1 = Closed (See Fig. 2 and Figure 9.)		13	35	ns
t_{PHZ}	Output disable time	$C_{RL} = 15pF$, S2 = Closed (See Fig. 2 and Figure 9.)		11	35	ns
f_{MAX}	Maximum data rate		5			Mbps

1. All currents into device pins are positive; all out of device pins are negative; all voltages are referenced to device ground unless specified

5 Test circuit and typical characteristics

Figure 2. Driver DC test load

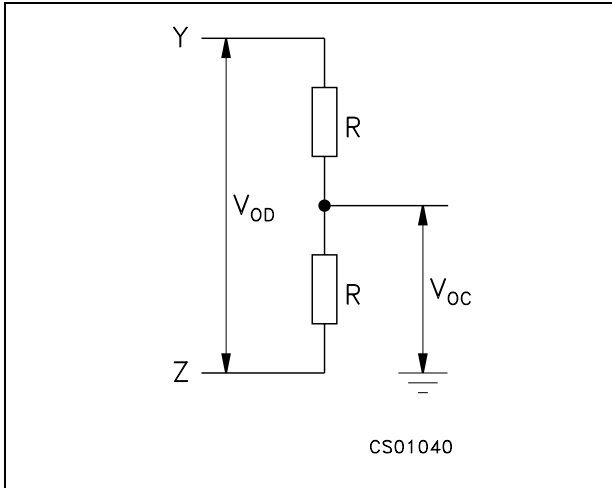


Figure 3. Receiver timing test load

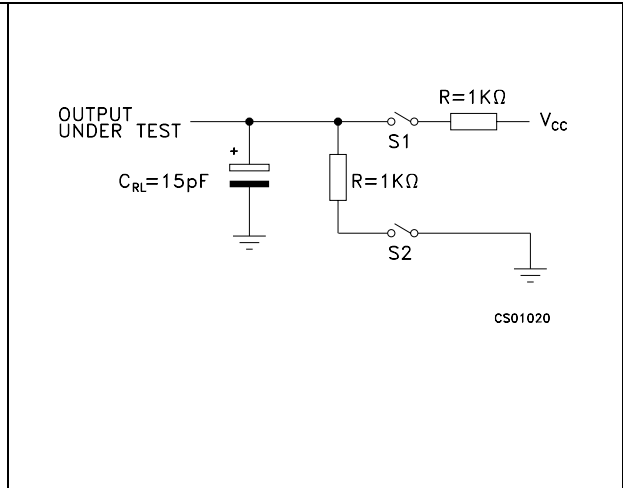


Figure 4. Drive/receiver timing test circuit

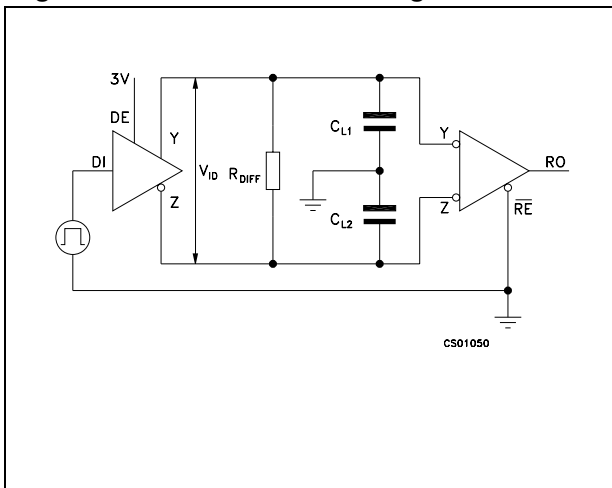


Figure 5. Driver timing test load

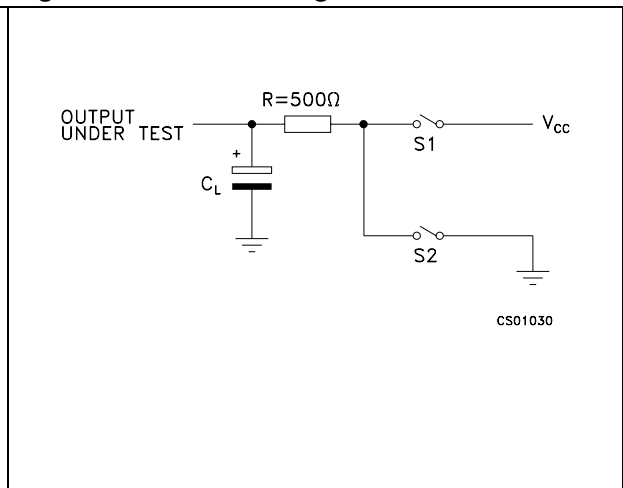


Figure 6. Driver propagation delay

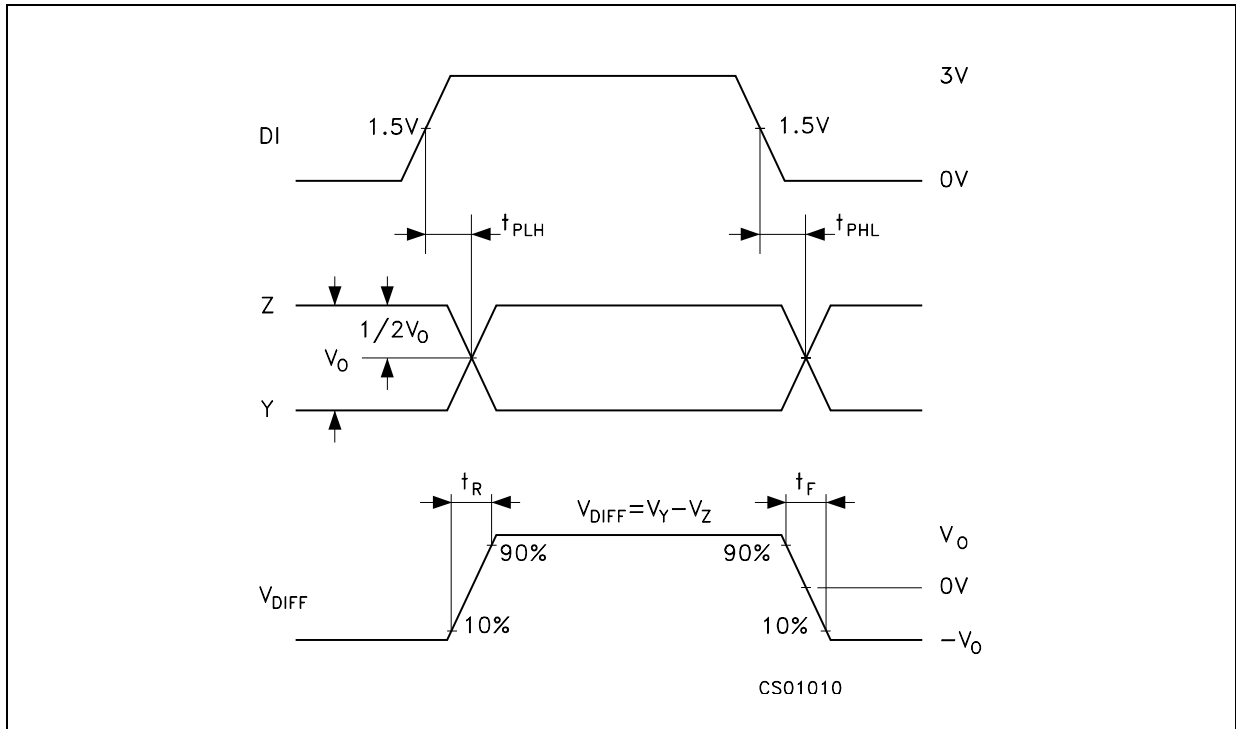


Figure 7. Driver enable and disable time

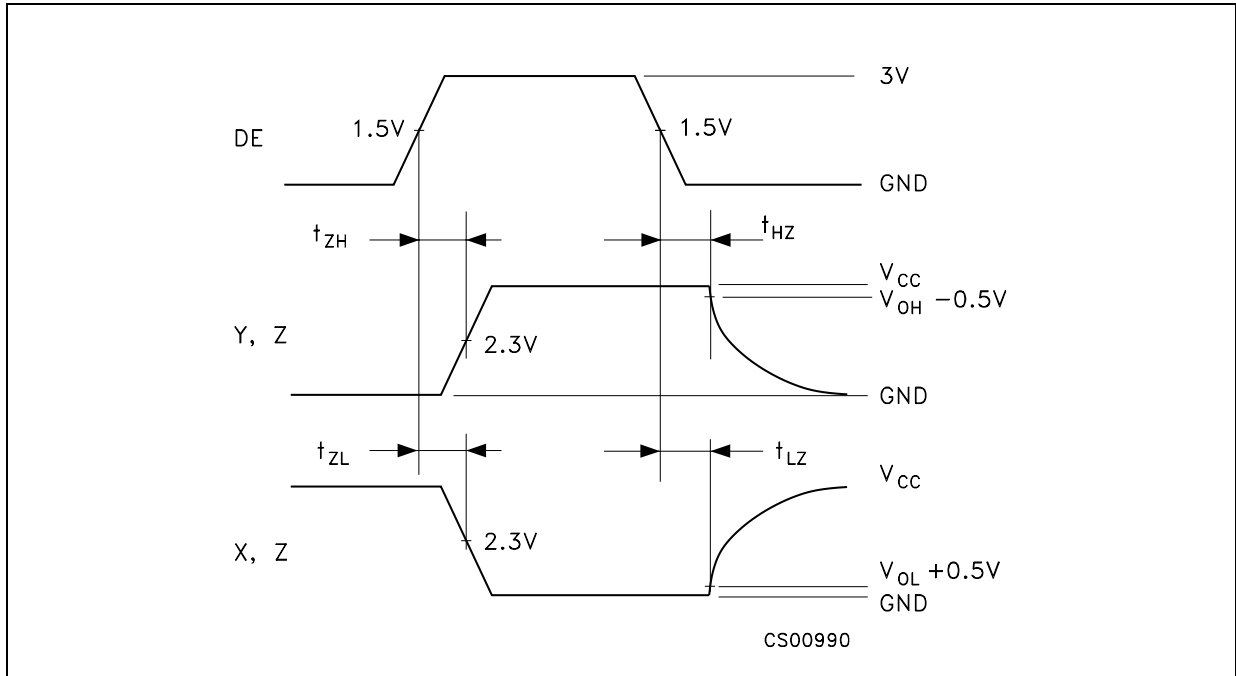


Figure 8. Receiver propagation delay

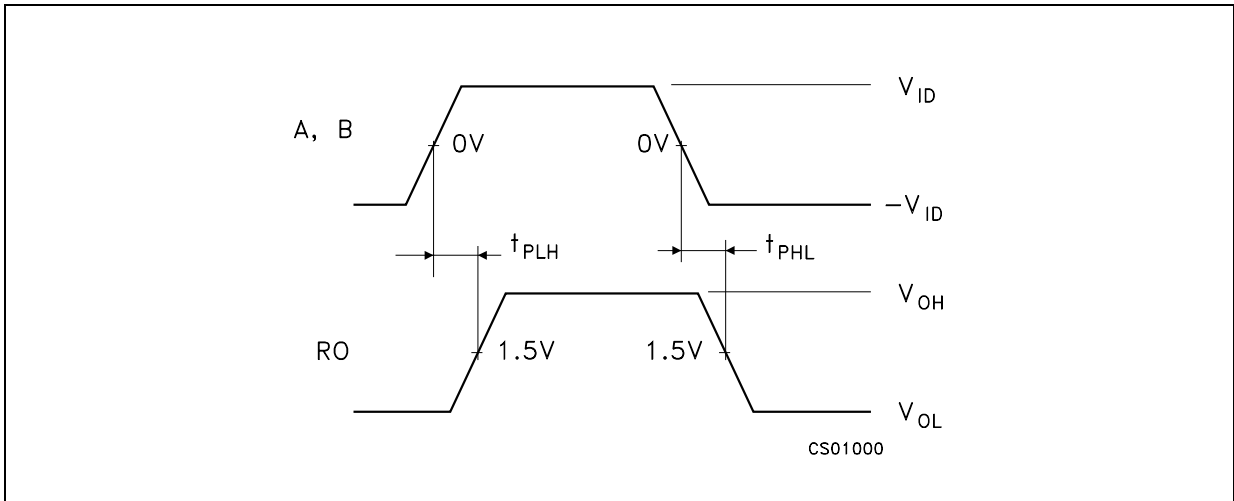


Figure 9. Receiver enable and disable time

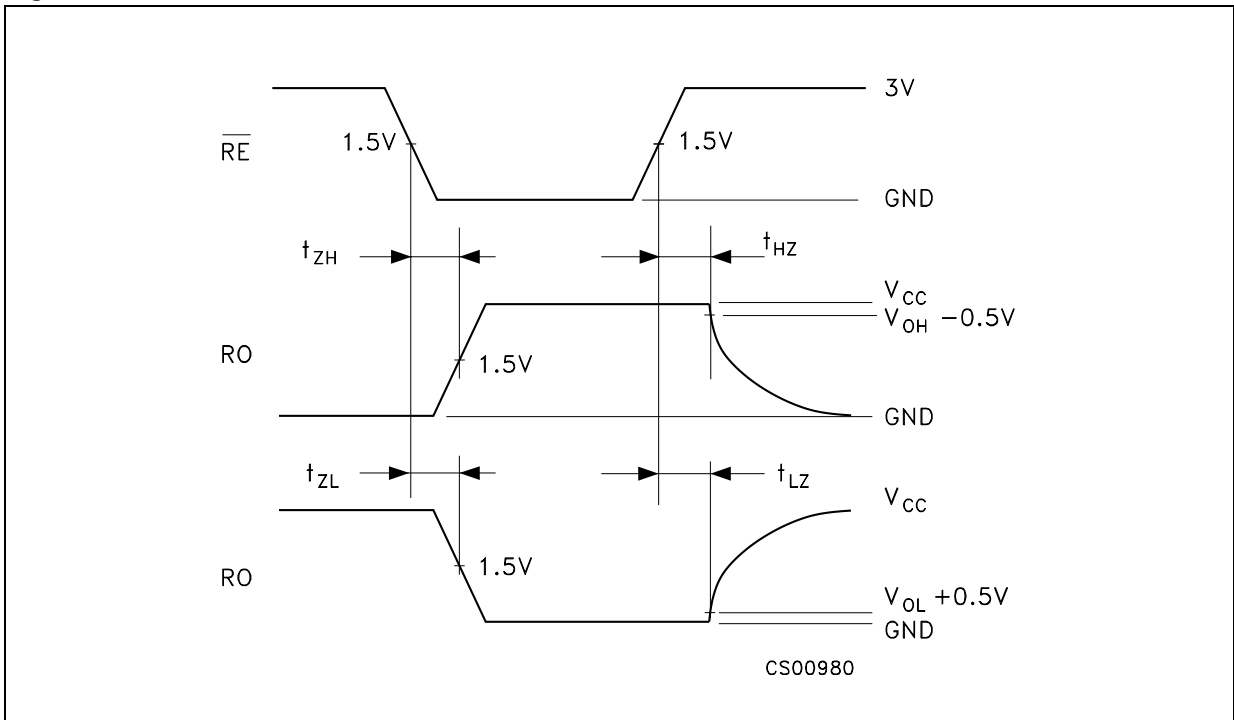


Figure 10. Receiver output current vs. output low voltage

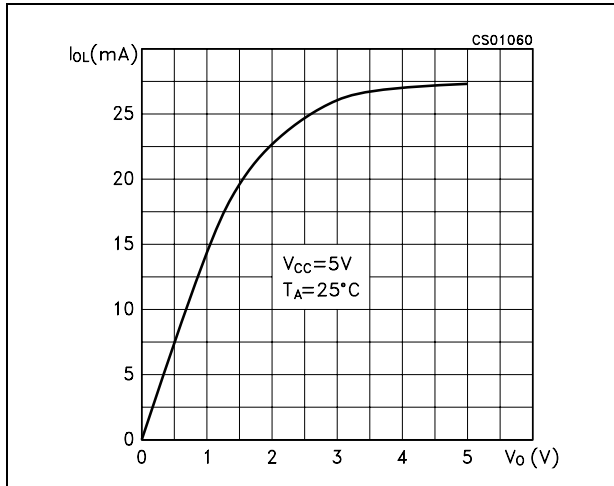


Figure 11. Receiver output current vs. output high voltage

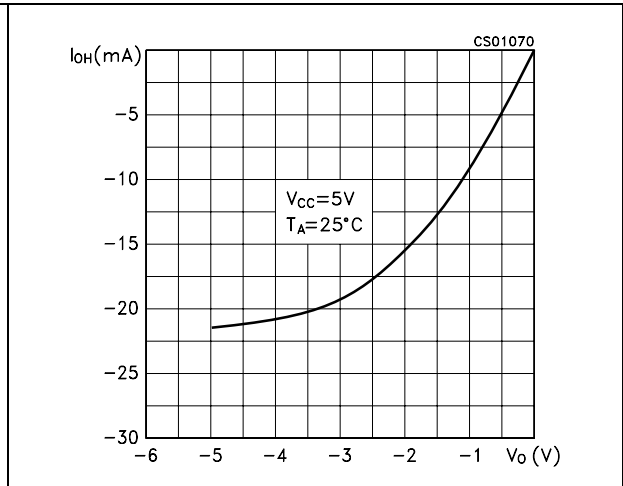


Figure 12. Driver output current vs. output low voltage

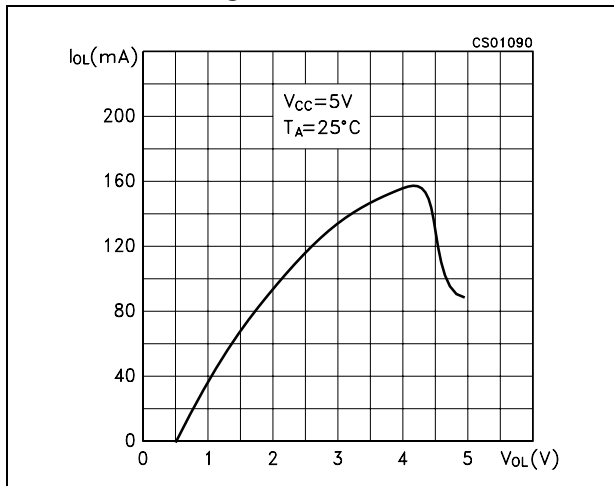


Figure 13. Driver output current vs. output high voltage

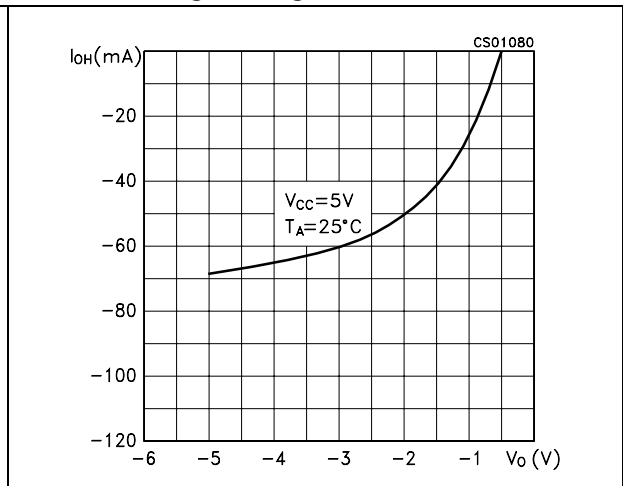


Figure 14. Supply current vs. temperature

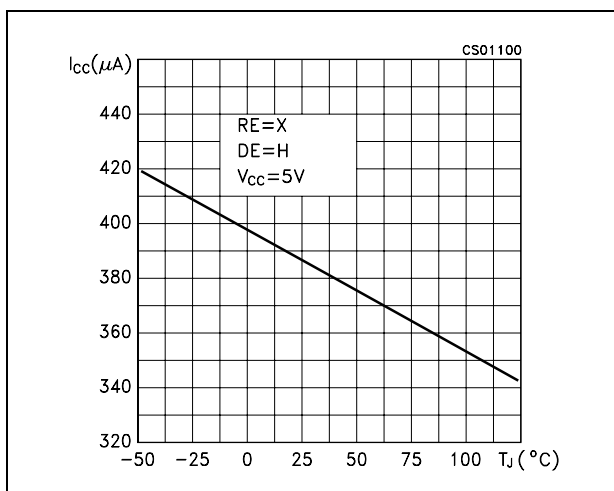


Figure 15. Receiver high level output voltage vs. temperature

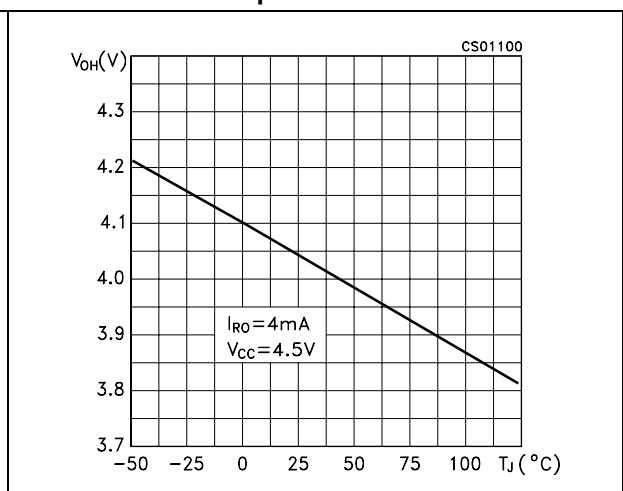


Figure 16. Receiver low level output voltage vs. temperature

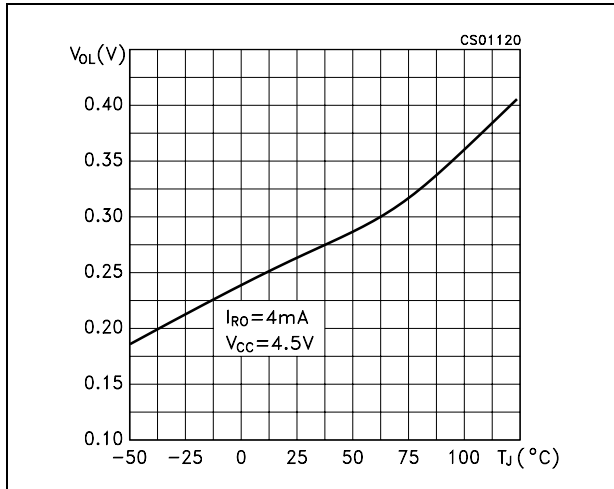
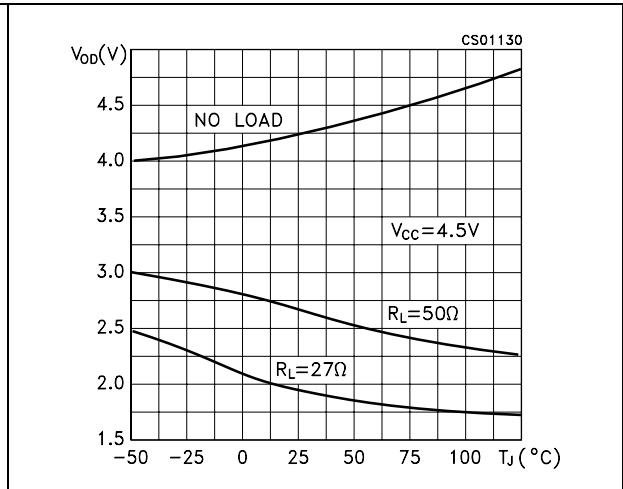


Figure 17. Differential driver output voltage vs. temperature

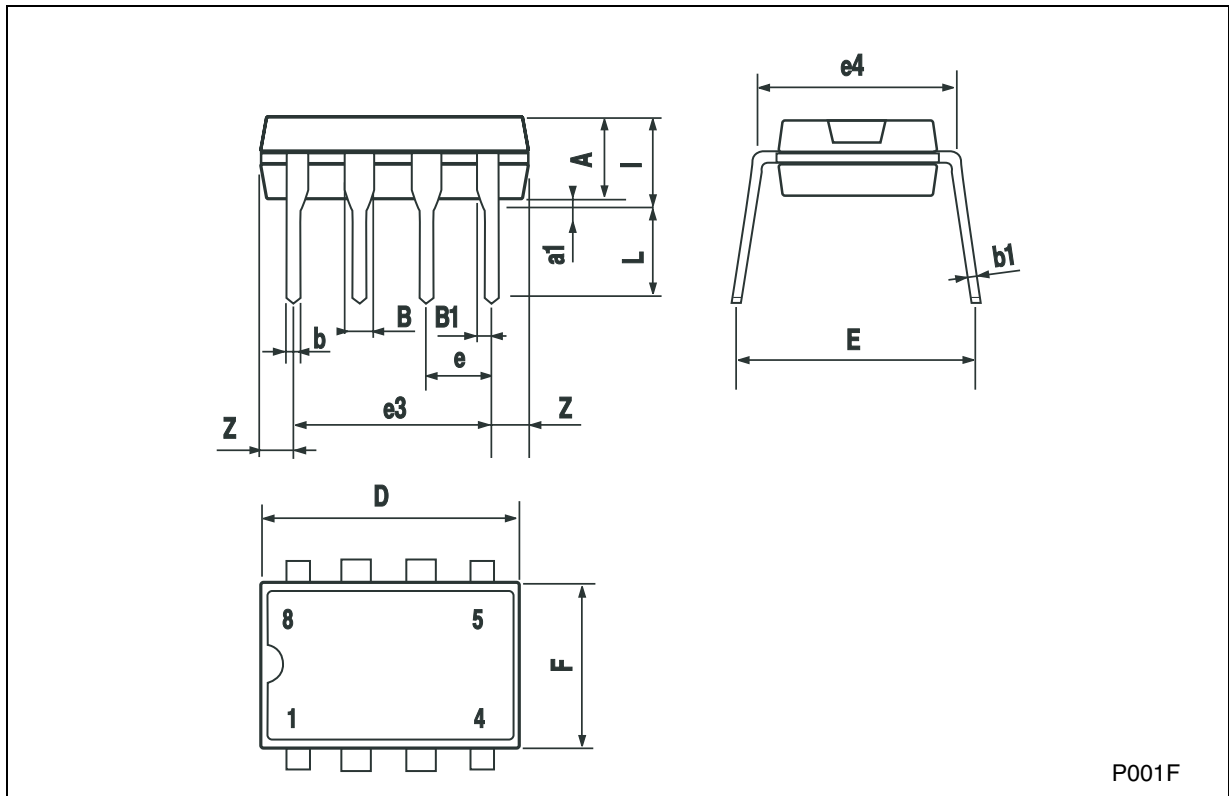


6 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

Plastic DIP-8 MECHANICAL DATA

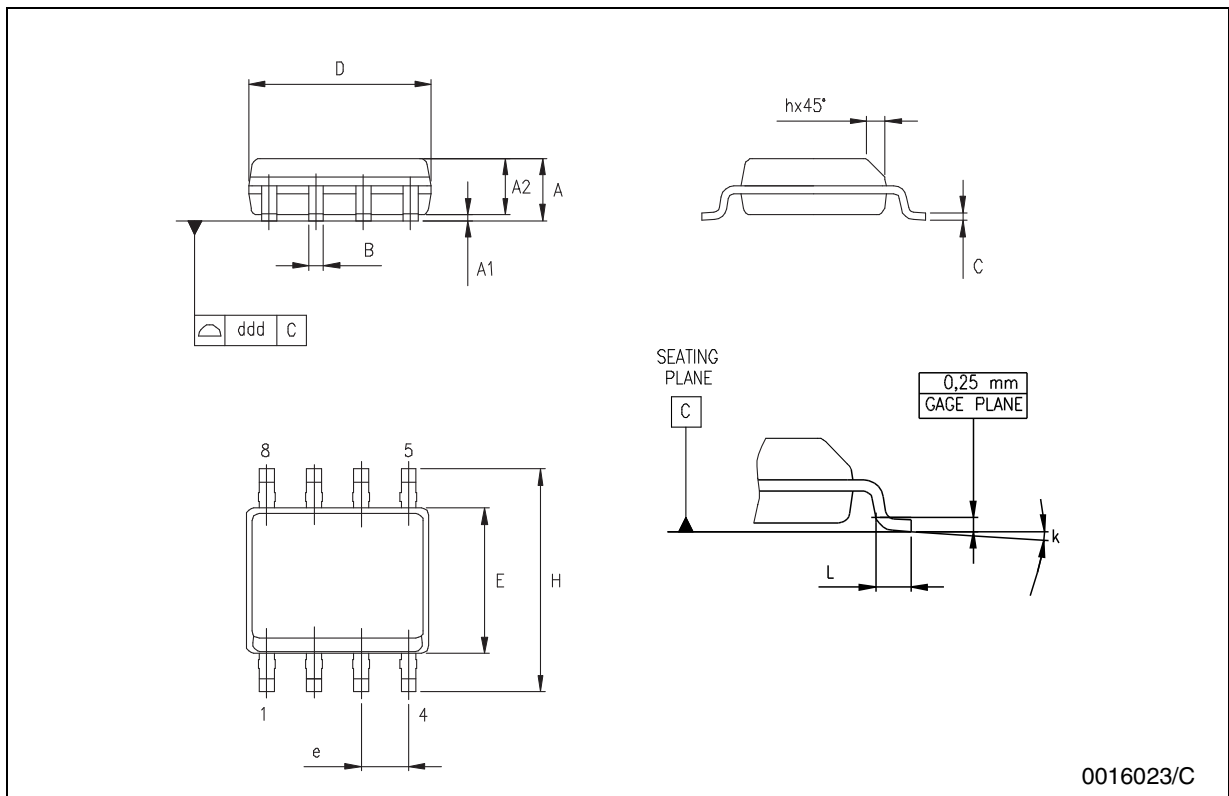
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A		3.3			0.130	
a1	0.7			0.028		
B	1.39		1.65	0.055		0.065
B1	0.91		1.04	0.036		0.041
b		0.5			0.020	
b1	0.38		0.5	0.015		0.020
D			9.8			0.386
E		8.8			0.346	
e		2.54			0.100	
e3		7.62			0.300	
e4		7.62			0.300	
F			7.1			0.280
l			4.8			0.189
L		3.3			0.130	
Z	0.44		1.6	0.017		0.063



P001F

SO-8 MECHANICAL DATA

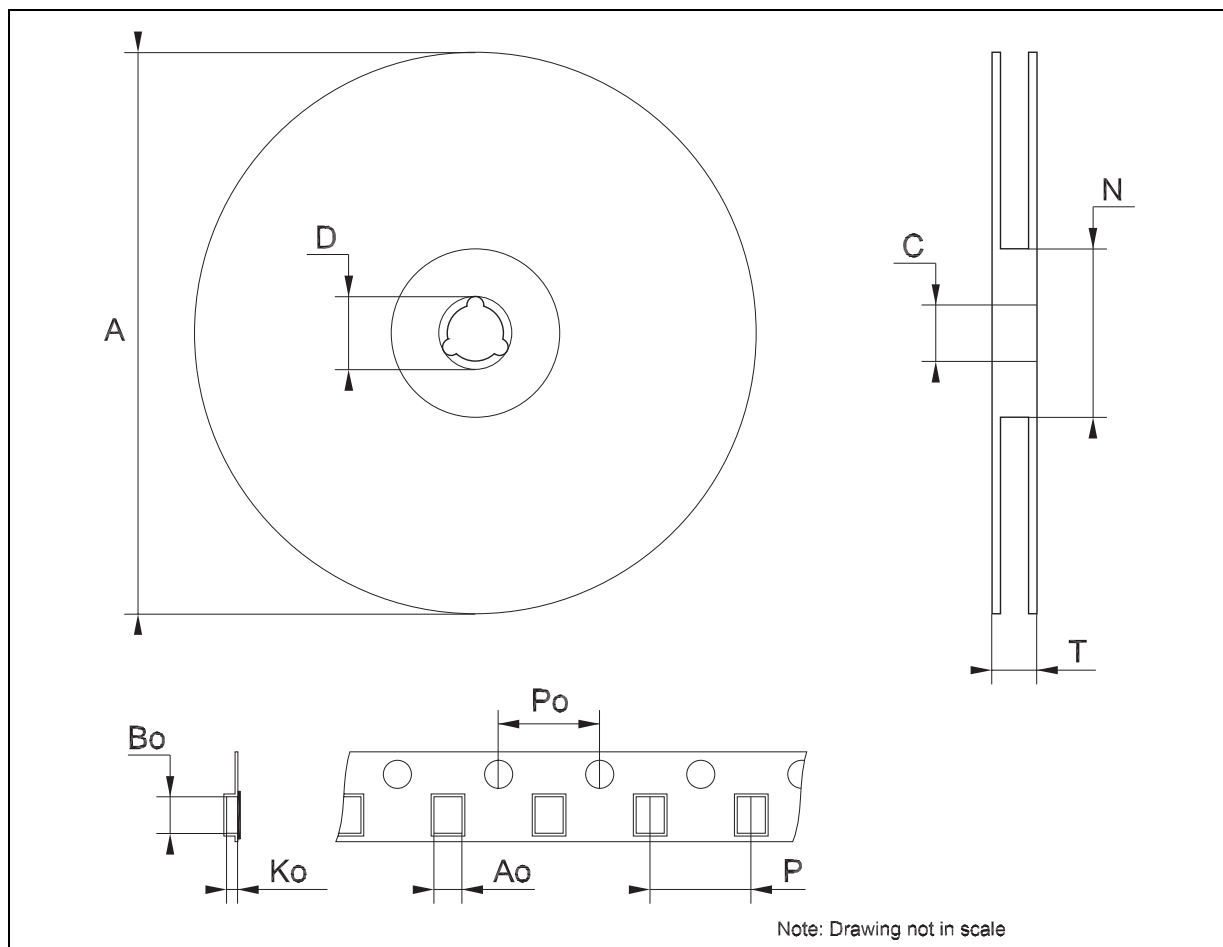
DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	1.35		1.75	0.053		0.069
A1	0.10		0.25	0.04		0.010
A2	1.10		1.65	0.043		0.065
B	0.33		0.51	0.013		0.020
C	0.19		0.25	0.007		0.010
D	4.80		5.00	0.189		0.197
E	3.80		4.00	0.150		0.157
e		1.27			0.050	
H	5.80		6.20	0.228		0.244
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
k	8° (max.)					
ddd			0.1			0.04



0016023/C

Tape & Reel SO-8 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			22.4			0.882
Ao	8.1		8.5	0.319		0.335
Bo	5.5		5.9	0.216		0.232
Ko	2.1		2.3	0.082		0.090
Po	3.9		4.1	0.153		0.161
P	7.9		8.1	0.311		0.319



7 Revision history

Table 9. Revision history

Date	Revision	Changes
21-Mar-2006	9	Order codes has been updated and new template.
05-Jun-2006	10	Change value row 10 in general features and R_{IN} in Table 6 .
29-Jan-2007	11	Typo mistake on page 1.

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